Call for Papers

International Institute of Innovative Acoustic Emission / 27th International Acoustic Emission Symposium / 11th International Conference on Acoustic Emission

Organized by The Japanese Society for Non-Destructive Inspection (JSNDI)
International Institute of Innovative Acoustic Emission (IIIAE)
Co-Sponsored by Acoustic Emission Working Group, U.S.A (AEWG)
European Working Group on Acoustic Emission(EWGAE)

Date: November 4-7, 2025

Venue: Nagoya Convention Hall

(4-60-12 Hiraike-chou, Nakamura-ku, Nagoya, Aichi, 453-6102, Japan)

Registration fee:

General	Early bird	¥110,000-	On or before May 31
	Regular	¥120,000-	After May 31
Student	Early bird	¥60,000-	On or before May 31
	Regular	¥70,000-	After May 31

^{*}The fee includes lunch, informal dinner, banquet, and various tours.

Language: English

Purpose: The IIIAE is an international society comprising the Japanese Society for Non-Destructive Inspection, AEWG (USA), and EWGAE (Europe). This conference aims to summarize the current status and latest advancements in AE technology while discussing future prospects. We will invite leading experts from the automotive and aerospace industries to deliver lectures and foster discussions that extend beyond AE, integrating diverse fields. Topics will include social issues and quality evaluation of civil engineering and building structures using 3D printing. To achieve this, we welcome presentations on non-destructive testing technologies across various fields, including mechanical, aerospace, civil engineering, architecture, medical, biological, and information processing—beyond AE technologies alone. We look forward to your participation.

(1) AE & Related NDT (2) Industries

(3) Machine Engineering (4) Geo-Resource Engineering

(5) Civil Engineering (6) Medical Science

(7) Materials Science (8) Signal Processing

(9) Sensor & System (9) Other

Submit paper: Please apply from the JSNDI Web site.

(https://www.jsndi.or.jp/gaku/sak/sak00.do?gaku=134)

Deadline for abstract submission: March 31, 2025 Deadline for manuscript submission: May 31, 2025

Website: https://2025.iiiae.org/